## SSB Series

## Serial Memory Bar Tokens

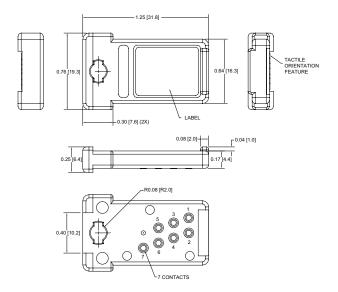


The power of memory, Secured.

The SSB series of Bar memory tokens contain 2 Kb to 256 Kb non-volatile, serial SPI EEPROM memory<sup>1</sup>. The memory is solid over-molded using a rugged composite that protects the embedded memory and is resistant to environmental influences such as vibration, ice, dirt, moisture, chemicals, and electrostatic discharge. Each token features a writable label<sup>4</sup> and is small enough to be carried in a pocket or to be placed on a keychain or lanyard. The SSB token is an ideal credential or low-capacity data transfer solution for harsh environment applications.



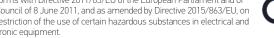
For pin-out information, refer to the datasheet for the Bar series of receptacles.



Drawing dimensions are in inches and millimeters [mm]. Dimensions are nominal and subject to manufacturer's tolerances.

Conforms with Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011, and as amended by Directive 2015/863/EU, on the restriction of the use of certain hazardous substances in electrical and electronic equipment









WARNING: Cancer and Reproductive Harm - www.P65Warnings.ca.gov

View the full product line at www.datakey.com

ATEK Access Technologies

www.atekaccess.com

SSB256Kb



- Complete SPI interface specification available at: www.datakey.com.
- See Bar receptacle datasheet for mechanical and environmental specificaitons when mated.
- "x" indicates optional color number. Contact ATEK for available color options. "A" suffix on part number indicates RoHS compliance. See CE declaration below for details.
- Label compatible with ball point pen (non-erasable), pencil (erasable) and grease pencil (erasable).

611-0186-00xA

It is recommended that all new key/token implementations be designed to operate with power supplies in the range of 2.7 to 3.6 volts. Although there are no immediate difficulties in procuring memory devices that operate in the 4.5 to 5.5 volt range, future availability may be impacted as semiconductor manufacturers shrink their die geometries.



Access the power of technology.